Overview

HP Elite Slice for Meeting Rooms G2 for Skype Room Systems



Side Ports/Collaboration buttons

- 1. USB Type-CTM 3.1 Gen 1 USB port
- 2. Audio-out (headphone)/audio-in (microphone)
- 3. Call
- 4. Mute

- 5. Volume down
- 6. Volume up
- 7. Hang up

HP Elite Slice for Meeting Rooms G2 for Skype Room Systems

Overview



Back Connectors

- 1. Power button
- 2. Power connector
- 3. RJ-45 (network) jack
- 4. USB Type-CTM 3.1 Gen 1 USB port (60 W input, DisplayPortTM Alternate Mode)
- 5. 2 USB Type A 3.1 Gen 1 ports
- 6. Dual-Mode DisplayPortTM (DP++)
- 7. HDMI port
- 8. UltraSlim cable lock slot

At A Glance

- One model available:
 - o HP Elite Slice for Meeting Rooms G2 for Skype Room Systems
- Modular system from the base that enhances the interactive experience through unique technology
- New HP Audio Module with capacitive touch Skype for Business keys (comes with HP Elite Slice for Meeting Rooms G2) for Call or Answer/ Mute/Volume Up/ Volume Down/ Hang up/End or Reject support
- The HP Audio Module speaker with side firing speakers and up-facing mics
- New Center of Room Control so that the meeting leader can easily manage the meeting to start/add people/share contact/end meeting functions without a PC
- New Video Ingest Module so that meeting attendees in the room can easily share content thru an HDMI port in the module
- Optional Cable-less Expansion Accessories (sold separately)
 - o HP ODD Module
 - o VESA Plate
- HP Sure Start with Dynamic Protection
- New HP Cable and Port Cover adapter secures the ports, prevents tampering, and provides cable management
- USB Type-CTM 3.1 with 60W power input
 - o Can be powered by a Display* and pass through DP with one cable

Overview

- Windows 10 IoT 64 Enterprise to have a dedicated OS to run the conferencing software
- UEFI BIOS developed and engineered by HP
- Intel® Q170 chipset supporting Intel® Peripheral Control Hub for 7th Gen CoreTM Processors, featuring integrated Intel HD Graphics and Intel® vProTM Technology
- Intel® HD Graphics 630
- Intel® Ethernet Connection I219LM GbE LOM integrated network connection
- DDR4-2400 (up to 32GB) Synchronous Dynamic Random-Access Memory (SDRAM)
- Multi-independent monitor support via HDMI and digital DisplayPortTM video interfaces
- Conexant CX7501 audio codec
- High efficiency energy saving power supply
- ENERGY STAR® certified. EPEAT® Gold registered where applicable/supported. See http://www.epeat.net for registration status by country.
- Low halogen
- Protected by HP Services, including limited warranties up to 3-3-3 (terms and conditions vary by country; certain restrictions and exclusions apply); Care Packs available with up to 5 years Next Business Day Onsite Hardware Support
- Lengthy purchase lifecycles and image stability

NOTE: See important legal disclosures for all listed specs in their respective features sections.

DA - 16229 Worldwide QuickSpecs — Version 2 — 6.21.2018

OPERATING SYSTEMS and Toplolgy requirements

Software Preinstalled

Windows 10 IoT 64 Enterprise CBB¹

Preinstalled

Windows 10 IoT 64 Enterprise CBB¹

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchase
hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically update
which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See
http://www.windows.com

Skype Room Systems V2 IT Topology Pre-Requisites (setup must be one of the these three):

- 1. Online Deployment (o365) Skype for Business Online with Exchange Online. *Active Directory Online
- On Premise Deployment Skype for Business Server 2015 On-Premises with Exchange 2013 SP1+ or later On-Prem. *Active Directory On-Prem
- 3. Hybrid Deployment Skype For Business 2015 On-Premise with Exchange Online/ Skype for Business 2015 Online with Exchange 2013 SP1+ On-Prem. *Active Directory On-Prem

Note(1): Skype Room Systems v2 does not support Lync Server 2013

Note(2): Preparation of the environment to enable SRS

- Ekype Ream Systems v2 needs to be assigned a "User account" in Active Directory, Exchange, and Skype for Business. The account is used to access its meeting calendar and establish Skype for Business connectivity. People can book this account by scheduling a meeting with it. Skype Room Systems v2 will be able to join that meeting and provide various features to the meeting attendees. Without a user account, none of these features will work. The user account & infrastructure must be correctly configured to allow SRS v2 to validate the user account and reach appropriate Microsoft services. For more information on configuration & licenses required: https://docs.microsoft.com/en-us/skypeforbusiness/room-systems/ [docs.microsoft.com]
- A Skype Room System client appliance PC with all required software installed
- Ecradelitional information on configuration & supported topologies: https://docs.microsoft.com/en-us/skypeforbusiness/deploy-skype-room-system [docs.microsoft.com/en-us/skypeforbusiness/deploy/deploy-clients/room-systems-v2-configure-accounts [docs.microsoft.com]

Technical Specifications

PROCESSOR

Intel® CoreTM i5^{2,3}

Intel® CoreTM i5-7500T vProTM Processor

35W

Up to 3.3 GHz Max. Turbo Frequency (2.7 GHz base frequency)

6 MB cache. 4 cores. 4 threads

Intel® HD Graphics 630

Supports DDR4 memory up to 2400 MT/s data rate

Supports Intel® vProTM Technology and Intel® Stable Image Platform Program (SIPP)

Intel® Core TM i5-7400T non vPro TM Processor

65 W

Up to 3 GHz Max. Turbo Frequency (2.4 GHz base frequency)

6 MB cache, 4 cores, 4 threads

Intel® HD Graphics 630

Supports DDR4 memory up to 2400 MT/s data rate

- 2. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on produc configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.
- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

GRAPHICS

Integrated

Intel® HD Graphics 630 with GT2 support4

4. HD content required to view HD images.



MEMORY

Both slots are customer accessible / upgradeable, Supports Dual Channel Memory

TypeMaximum# of SlotsDDR4-2400 (Transfer rates up to 2400 MT/s)32 GB capacity2 DIMM

Configurations

8 GB DDR4-2400 SODIMM (2x4GB) (Dual Channel)

STORAGE

Technical Specifications

Solid State Drives M.2 NVMe⁵

256 GB PCIe NVMe M.2 Solid State Drive 128 GB PCIe NVMe M.2 Solid State Drive

SATA Solid State Drives 2.5"?⁵

256 GB SSD TLC SATA Drive
128 GB SSD TLC SATA Drive

5. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

NETWORKING

Ethernet (RJ-45)

Wired Intel® i219LM GbE LOM

Wireless (optional and must be configured at purchase)⁶

Intel® 7265 ac 2x2 +Bluetooth non-vProTM

Intel[®] 8260 ac 2x2 +Bluetooth vProTM

Intel® 8260 ac 2x2 +Bluetooth non-vProTM

6. Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

AUDIO / MULTIMEDIA

Conexant CX20926

1x Universal audio jack

Four speakers with dual passive radiator stereo sound system

HP Audio Module 2.0

Four Digital Microphones

KEYBOARDS AND POINTING DEVICES

Technical Specifications

Keyboards⁷

HP Business Slim USB Keyboard (China Only) HP Business Slim USB Keyboard

Mice⁷

HP USB Optical Mouse

HP Mouse Pad

HP USB Mouse (China only)

7. Keyboards and mice are optional or add-on features.

PORTS

External I/O Ports

- 1 Universal audio jack (with re-tasking) connector
- 1 USB Type-CTM (USB 3.1 Gen 1, 15W output) connector
- 1 USB Type-A (USB 3.1, charging) connector
- 1 USB Type-A (USB 3.1, S4/S5 wake) connector
- 1 USB Type-CTM (Alternate Mode DP, USB 3.1 Gen 1, 15W output, 60W input) connector
- 1 DisplayPortTM connector
- 1 HDMI connector (optional HP DisplayPortTM)
- 1 RJ-45 connector
- 1 DC-in 7.4mm barrel

Internal I/O Ports

1. M.2 nVME

1 SATA

SLOTS

1 M.2 2230 PCIe for WLAN

1 M.2 2280 PCIe for NVMe SSD

ADDITIONAL MODULES

HP Cable and Port cover
HP Center of Room Control^{8,9}
HP Video Ingest Module
VESA Mount¹⁰

- 8. Dimensions: Width (X) 301.75mm or 11.88 in; Height(Y) 219.75mm or 8.65 in; Depth (Z) 80.8mm or 3.17 in; Weight: 1040 grar or 2.3 lbs
- 9. 31.2 cm (12.3") diagonal FHD LCD touch screen (1920 x 1280)
- 10. Only can be purchased as an optional feature at time of sale

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS

Absolute Persistence Module¹¹ HP Wireless Wakeup

Software

HP Velocity

HP Recovery Manager

HP Support Assistant¹²

HP Connection Optimizer

HP Collaboration Keyboard Software

Microsoft Skype Room Systems

HP Notifications

11. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscription can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

12. HP Support Assistant requires Windows and Internet access.

SECURITY MANAGEMENT

Sure Start 2.0 with private SPI flash Active Health (Black box flight recorder) Infineon TPM SLB9670 TPM 2.0 / TPM 1.2

HP Dual Head Keyed Cable Lock Kit (optional and must be configured at purchase)

POWER SUPPLY

90W AC adapter¹³ Up to 85% efficient

13. All power supplies are not available in every region.

DIMENSIONS AND WEIGHT (configured with 1 HDD)

Chassis 6.5 x 6.5 x 4.4 in (H x W x D) 165 x 165 x 112 mm

System Weight 3.36 lb / 1.52 kg

PACKAGING DIMENSIONS AND WEIGHT

Dimensions 23.5 x 10.75 x 8 in

596.9 x 273.05 x 203.2 mm

Weight 14.71 lb / 6.67 kg

COLOR

Sparkle black color

HP VIDEO INGEST MODULE



Functionality

- 1080 Resolution support
- 60Hz refresh
- 1 x HDMI 1.4 input port
- Works in MS SRS with Present option (button)
- Display input to local display and meeting

HP CENTER OF ROOM CONTROL



Functionality

- See full Room Calendar for scheduled calls
- Initiate ad-hoc calls, dial out, or invite participants
- Toggle Skype views with Gallery, content, maximize 2x LDF for conferencing
- Volume control & Mute on CoRC & Collab buttons
- Fully replace the phone in the conference room
- Tool-less Type-C cable installation with stand cover module

Display

- 12.5"? diagonal screen
- Type-C interface
- Dual orientation
- 1440 x 960 resolution
- 3:2 aspect ratio
- 10-point touch capable

Orientations

- 25 degrees horizontal
- 48 degrees horizontal

Sensor

• Pyro-electric IR-Detectors

PORT COVER



Functionality

- Tamper-proofing of cables from the back of Slice
- Extends Power, 2 USB Type-A, RJ45, DisplayPort, and HDMI cables for connections under the table
- Clean single condensed cable for single group of cables extended from Slice
- Separate Type-C cable for easy movement of Center Of Room Control display on the table
- Cover to hide back connections to Slice

SERVICE AND SUPPORT

On-site Warranty: Protected by an HP standard three-year (3-3-3) or one-year (1-1-1) limited warranty (varies by region). Certair restrictions and exclusions apply. Limited warranty delivers next business day service for parts and labor and includes Complimentary Limited Technical Support. One-year onsite and labor are not available in all countries. Service offers terms up to years by choosing an optional HP Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, a is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical support applies only to HP-configured and third-party HP qualified hardware and software.

DUNTRY OF ORIGIN						
China						

Tec	hnical	Speci	ficati	ons
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HIGH DEFINITION AUDIO

Audio by Bang & Olufsen				
Туре	Four speakers with dual passive radiator stereo sound system			
HD Stereo Codec	1x Universal audio jack (w/ re-tasking)			
Audio I/O Ports	High Definition Audio			
Internal Speaker Amplifier	TI TAS5754M			
Sampling	Conexant CX20926			
Analog Audio	1x Universal audio jack			
# of Channels	Yes - Uses OS soft wavetable			
Internal Speaker	Yes - four speakers			
DAC Sampling Rates	44.1 kHz/48 kHz/96 kHz			
ADC Sampling Rates	44.1 kHz/48 kHz/96 kHz			

GRAPHICS

Intel® HD Graphi	cs 630 (integrated)						
DisplayPort TM 1.2	Multimode capable; supports HDCP, DisplayPort TM Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 3 displays (including the integrated panel)						
Memory	The BIOS has options for selecting t	he dedicated memory size of 128M	B, 256MB or 512MB				
	Additional memory is allocated for (DVMT), to provide an optimal balar						
Maximum Graphics	Microsoft Windows 7	Windows 8.1	Windows 10				
Memory	Up to 1.7GB	Up to 1.8GB	>4 GB				
	Note: the actual amount of maximum graphics memory can be less than the amounts listed above depend upon your computer's configuration.						
Maximum Color Depth	32 bits/pixel						
Graphics/Video API Support	32 bits/pixel 6th Generation Core TM processors: • Next Generation Intel® Clear Video Technology HD Support is a collection of video playst and enhancement features that improve the end user's viewing experience • Encode/transcode HD content • Playback of high definition content including Blu-ray Disc • Superior image quality with sharper, more colorful images • DirectX Video Acceleration (DXVA) support for accelerating video processing • Full AVC/VC1/MPEG2/HEVC HW Decode • Advanced Scheduler 2.0, 1.0 • Windows 7, Windows 8.1, Windows 10, Linux OS Support • DirectX 12.1 • OpenGL 4.4 • Open CL 1.2 (Intel® HD Graphics 510)						

Supported Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP. For All in C platforms, resolutions higher than the integrated panel resolution are not supported on the integrated panel.

Resolution	Refresh Rate	VGA	DisplayPort TM 1.2	HDMI	Standard
640 x 480	60, 75, 85	X	X	Х	VESA DMT, CVT 0.31M3
720 x 400	70	Х	X	Х	IBM VGA
800 x 600	60, 75, 85	Х	X	Х	VESA DMT, CVT0.48M3
1024 x 768	60, 75, 85	Х	X	Χ	VESA DMT, CVT 0.79M3
1152 x 864	60, 75, 85	Х	X	Х	VESA DMT, CVT 0.83MA
1280 x 720	60, 75, 85	Х	X	Х	VESA DMT, CVT 0.92M9, CEA-770.3

Technical Specifications

1280 x 768	60, 60RB, 75, 85	x	l x	x	VESA DMT, CVT 0.98M9/0.98M9-R
1280 x 800	60, 75, 85	Х	Х	X	VESA DMT
1280 x 960	60, 75, 85	X	X	X	VESA DMT
1280 x 1024	60, 75, 85	X	X	X	VESA DMT, CVT 1.31M4
1366 x 768	60, 60RB	X	X	X	VESA DMT
1440 x 900	60, 60RB	X	X	X	VESA DMT
1600 x 900	60, 60RB, 75, 85	X	X	X	VESA DMT
1680 x 1050	60, 60RB, 75	X	X	X	VESA DMT, CVT 1.76MA/1.76MA-R
1920 x 1080	60	X	X	X	VESA DMT, CVT 2.07M9, SMPTE 274M
1920 x 1200	60, 60RB, 75, 85	X*	X	X	DMT, CVT 2.30MA/2.30MA-R
1600 x 1200	60, 75, 85	X*	X	X	VESA DMT, 1.92M3
1920 x 1440	60, 75, 85	1	Х	X	VESA DMT, CVT 2.76M3
2048 x 1536	60,75		Х	X	CVT 3.15M3
2560 x 1440	59.951		X	X	CVT 3.69M9-R
2560 x 1600	60, 60RB		Х	X	VESA DMT, CVT 4.10MA/4.10MA-R
3440 x 1440	60		Х	X	VESA DMT, CVT 0.31M3
3440 x 1440	75, 85		Х	1	VESA DMT, CVT 0.31M3
3840 x 2160	24		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	25		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	30		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	50		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
3840 x 2160	60		Х	Х	CVT-RBv1/v2 (8.29M9-R), SMPTE 274M
4096 x 2160	24		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	25		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	30		Х	X	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	50		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
4096 x 2160	60		Х	Х	CVT-RBv1/v2 (8.85M-R), SMPTE 274M
1920 x 1080	60		Х	Х	VESA (SMPTE 274M)
1920 x 1080	50		Х	X	SMPTE 274M
1920 x 1080	30		Х	Х	SMPTE 274M
1920 x 1080	24		Х	Х	SMPTE 274M
1280 x 720	60		Х	Х	VESA (CEA-770.3)
1280 x 720	50		Х	Х	SMPTE 296M
720 x 480	60		Х	Х	MHL (CEA-770.2)
720 x 576	50		Х	Х	ITU-R BT.1358
640 x 480	60		Х	Х	CEA (VESA DMT)

STORAGE



Unformatted Capacity	128 GB			
Architecture	TLC NAND Flash			
Interface	SATA 3.2 (6.0 Gb/s)			
Form Factor	2.5 inch			
Dimensions (W x D x H)	6.98 x 10.05 x 0.7 cm			
Weight	31g			
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s		
	Sustained Sequential Write:	Up to 330 MB/s		
	Random Read:	Up to 38K IOPs		
	Random Write:	Up to 70K IOPs		
Power	DC power requirement:	5 VDC 5%-100 mV ri	pple p-p	
	Total power consumption:	50mW (active); 20m	W (idle)	
Useful Drive Life	72TB written, up to 40GB/	day for 5 years		
Environmental	Operating Temperature:	Operating Temperature:		
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

Unformatted Capacity	256 GB				
	230 00				
Architecture	TLC NAND Flash				
Interface	SATA 3.2 (6.0 Gb/s)				
Form Factor	2.5 inch				
Dimensions (W x D x H)	6.98 x 10.05 x 0.7 cm				
Weight	31g				
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s			
	Sustained Sequential Write:	Up to 330 MB/s			
	Random Read:	Up to 38K IOPs			
	Random Write:	Up to 70K IOPs			
Power	DC power requirement:	5 VDC 5%-100 mV r	pple p-p		
	Total power consumption:	50mW (active); 20m	W (idle)		
Useful Drive Life	72TB written, up to 40GB/	day for 5 years			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)		
(all conditions, non-condensing)	Relative Humidity:	Relative Humidity:			
	Shock:		1,500 G/0.5 ms		

NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

128 GB M.2 2280 PCIe NVMe SSD

Drive Weight < 10g
Capacity 128GB
Height 2.38mm
Length 80mm
Width 22mm
Interface PCIE Gen3

Performance Up to Random Read/Write = 60K/50K IOPS

Maximum Sequential ReadUp to 1400MB/sMaximum Sequential WriteUp to 395MB/sLogical Blocks250,069,680

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE:For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

256 GB M.2 2280 PCIe NVMe SSD

Drive Weight < 10g
Capacity 256GB
Height 2.38mm
Length 80mm
Width 22mm
Interface PCIE Gen3

Performance Up to Random Read/Write = 120K/170K IOPS

Maximum Sequential ReadUp to 1600MB/sMaximum Sequential WriteUp to 780MB/sLogical Blocks500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

NOTE:For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

NETWORKING

Intel 8260 802.11a/b/g/n/ac (2x2) WiFi and Bluetooth® 4.2 Combo Non-vPro					
Wireless LAN Standards	IEEE 802.11a				
	IEEE 802.11b				
	IEEE 802.11g				
	IEEE 802.11n				
	IEEE 802.11ac				
Interoperability	Wi-Fi certified				
Frequency Band	802.11b/g/n				
	_				

Technical Specifications

	• 2.402 - 2.482 GHz
	802.11a/n
	• 4.9 - 4.95 GHz (Japan)
	• 5.15 - 5.25 GHz
	• 5.25 - 5.35 GHz
	• 5.47 - 5.725 GHz
	• 5.825 - 5.850 GHz
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz,
	40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for
	a/b/g mode only
	 AES-CCMP: 128 bit in hardware
	802.1x authentication
	 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and
	AES.
	 WPA2 certification
	• IEEE 802.11i
	 Cisco Certified Extensions, all versions through CCX4 and
	CCX Lite
	• WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
-	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	 802.11n HT20(2.4GHz): +13dBm minimum
	• 802.11n HT40(2.4GHz): +13dBm minimum
	• 802.11n HT20(5GHz): +12dBm minimum
	• 802.11n HT40(5GHz): +12dBm minimum
	 802.11ac 80MHz(5GHz) : +11dBm minimum
Power Consumption	Transmit mode2.0 W
•	Receive mode1.6 W
	 Idle mode (PSP)180 mW (WLAN Associated)
	 Idle mode50 mW (WLAN unassociated)
	Connected Standby 10mW
	Radio disabled8 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -93.5dBm maximum
	802.11b, 11Mbps : -84dBm maximum
	802.11a/g, 6Mbps : -86dBm maximum
	802.11a/g, 54Mbps : -72dBm maximum
	802.11n, MCS07 : -67dBm maximum
	802.11n, MCS15 : -64dBm maximum
	802.11ac, MCS0 : -84dBm maximum
	802.11ac, MCS9 : -59dBm maximum

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rechnical Spe	CHICALIONS			
	Antenna type	High efficiency ar	ntenna with spatial diversity, mounted in the displa	
		enclosure	·	
		Two embedded d	ual band 2.4/5 GHz antennas are provided to the	
			VLAN MIMO communications and Bluetooth®	
		communications		
	Form Factor	PCI-Express M.2 N	MiniCard	
	Dimensions	Туре 2230 : 2.3 х	22.0 x 30.0 mm	
	Weight	Type 2230 : 2.8g		
	Operating Voltage	3.3v +/- 9%		
	Temperature	Operating	14° to 158° F (-10° to 70° C)	
		Non-operating	-40° to 176° F (-40° to 80° C)	
	Humidity	Operating	10% to 90% (non-condensing)	
		Non-operating	5% to 95% (non-condensing)	
	Altitude	Operating	0 to 10,000 ft (3,048 m)	
		Non-operating	0 to 50,000 ft (15,240 m)	
	LED Activity		io OFF; LED White - Radio ON	
HP Integrated N	Module with Bluetooth 4.0/4.1/4.2 Wireles	s Technology		
	Bluetooth® Specification	4.0/4.1/4.2 Compl	iant	
	Frequency Band	2402 to 2480 MHz		
1	Number of Available Channels	Legacy : 0~79 (1 M	·	
	ramber of Available Chainets	BLE: 0~39 (2 MHz)		
	Data Rates and Throughput		ata rate; throughput up to 2.17 Mbps	
	vata kates and i mougnput		rate; throughput up to 2.17 mops rate; throughput up to 0.2 Mbps	
			rate; throughput up to 0.2 Mbps ous Connection Oriented links up to 3, 64 kbps, vo	
		channels	ous connection oriented links up to 3, 64 KDps, vo	
			nous Connection Lass links 2170 1 kbss/177 1 kbs	
		Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbp asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)		
H	Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.		
	I I allolli C POWEF			
H	Dawer Commentian	·		
	Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW		
H		Selective Suspend 17 mW		
-	Electrical Interface	USB 2.0 compliant		
	Bluetooth® Software Supported	Microsoft Window	s Bluetooth® Software	
1	Link Topology			
	Power Management	Microsoft Window	s ACPI, and USB Bus Support	
]	Certifications	FCC (47 CFR) Part 1	15C, Section 15.247 & 15.249	
1	Power Management	ETS 300 328, ETS	·	
	Certifications	Low Voltage Direc		
	cei ciricacions	UL, CSA, and CE Ma		
П		on, cort, and ce M	····	
H		DTA 1 ECD E/E/7 C	`amplianca	
		BT4.1-ESR 5/6/7 C LE Link Layer Ping	•	
		LE Dual Mode		
		LE Link Layer		
		-	Directed Advertising	
			ion Oriented Channels	
		Train Nudging & In		
	Bluetooth® Profiles Supported	BT4.2 ESR08 Comp		
	Diversión, Legaries Subborted	LE Secure Connect		
		LE Privacy 1.2 -Lin		
		-	tended Scanner Filter Policies	
			11. 🖻 . 1	
		LE Data Packet Ler	ngth Extension	
		FAX Profile (FAX)		
		1	ile (BIP)2	

Technical Specifications

Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)

Wireless LAN Standards	IEEE 802.11a
Wiletess LAN Stalldards	
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 - 2.482 GHz
	802.11a/n
	• 4.9 - 4.95 GHz (Japan)
	• 5.15 - 5.25 GHz
	• 5.25 - 5.35 GHz
	• 5.47 - 5.725 GHz
	• 5.825 - 5.850 GHz
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	802.11ni. MCS 0 ~ MCS 15, (20M12, and 40M12) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz,
AA. J. 1. 1. 1.	40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for
	a/b/g mode only
	 AES-CCMP: 128 bit in hardware
	802.1x authentication
	 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, ar
	AES.
	WPA2 certification
	• IEEE 802.11i
	Cisco Certified Extensions, all versions through CCX4 and
	CCX Lite
	WAPI
Note and Aughternaum	
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	 802.11n HT20(2.4GHz): +13dBm minimum
	 802.11n HT40(2.4GHz) : +13dBm minimum
	• 802.11n HT20(5GHz): +12dBm minimum
	• 802.11n HT40(5GHz): +12dBm minimum
	802.11ac 80MHz(5GHz) : +11dBm minimum
Power Consumption	Transmit mode2.0 W
. over consumption	Receive mode1.6 W
	Idle mode (PSP)180 mW (WLAN Associated) Idle mode (PSP)180 mW (WLAN Associated)
	Idle mode50 mW (WLAN unassociated)
	 Connected Standby 10mW
	Radio disabled8 mW
Power Management	ACPI and PCI Express compliant power management
_	802.11 compliant power saving mode

Technical Specifications

	Receiver Sensitivity ³	802.11b, 1Mbps : -	93.5dBm maximum	
		802.11b, 11Mbps:	-84dBm maximum	
		802.11a/q, 6Mbps	: -86dBm maximum	
			s : -72dBm maximum	
		802.11n, MCS07 : -		
		802.11n, MCS15 : -		
		802.11ac, MCS0 : -		
		802.11ac, MCS9 : -		
	Antonno tuno		enna with spatial diversity, mounted in the display	
	Antenna type	-	erina with Spatial diversity, mounted in the display	
		enclosure	allowed 2 A/E CH and a second and a second	
		I	al band 2.4/5 GHz antennas are provided to the	
			LAN MIMO communications and Bluetooth®	
		communications		
	Form Factor	PCI-Express M.2 M		
	Dimensions	Type 2230 : 2.3 x 2	22.0 x 30.0 mm	
	Weight	Type 2230 : 2.8g		
	Operating Voltage	3.3v +/- 9%		
	Temperature	Operating	14° to 158° F (-10° to 70° C)	
		Non-operating	-40° to 176° F (-40° to 80° C)	
	Humidity	Operating	10% to 90% (non-condensing)	
	- indiminancy	Non-operating	5% to 95% (non-condensing)	
	Altitude	Operating	0 to 10,000 ft (3,048 m)	
	nttituue	'	0 to 50,000 ft (15,240 m)	
	LED Activity	Non-operating	o OFF: LED White - Radio ON	
	LED Activity		OUFF; LED WHITE - RAUIO UN	
HP Integrated I	Module with Bluetooth 4.0/4.1/4.2 Wireles			
	Bluetooth® Specification	4.0/4.1/4.2 Complia	ant	
	Frequency Band	2402 to 2480 MHz		
	Number of Available Channels	Legacy : 0~79 (1 Mi	17/CH)	
		BLE: 0~39 (2 MHz/0		
H	Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps		
	Data Rates and Timougnput		ate; throughput up to 0.2 Mbps	
			ous Connection Oriented links up to 3, 64 kbps, voic	
		channels	us connection oriented tilks up to 3, 04 kbps, voic	
			ous Connection Loss links 2179 1 kbps/177 1 kbps	
			ous Connection Less links 2178.1 kbps/177.1 kbps	
			5) or 864 kbps symmetric (3-EV5)	
П	Tuescomit Devices	The Bluetooth com	ponent shall operate as a Class II Bluetooth device	
	Transmit Power			
	Transmit Power		ansmit power of + 4 dBm for BR and EDR.	
	Power Consumption	with a maximum tr	ansmit power of + 4 dBm for BR and EDR.	
		with a maximum tr	ansmit power of + 4 dBm for BR and EDR.	
		with a maximum tr	·	
		with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend	·	
	Power Consumption Electrical Interface	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant	17 mW	
-	Power Consumption Electrical Interface Bluetooth® Software Supported	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant	·	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows	17 mW Bluetooth® Software	
	Power Consumption Electrical Interface Bluetooth® Software Supported	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows	17 mW	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows	17 mW Bluetooth® Software	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1	17 mW Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3	17 mW Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct	17 mW Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tr Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3	17 mW Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum transport of the peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend of the peak (Rx) 230 mW USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum transport of the peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai BT4.1-ESR 5/6/7 Cc LE Link Layer Ping LE Dual Mode	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai BT4.1-ESR 5/6/7 Co LE Link Layer Ping LE Dual Mode LE Link Layer	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950 ·k ompliance	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai BT4.1-ESR 5/6/7 Co LE Link Layer Ping LE Dual Mode LE Link Layer	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950	
	Power Consumption Electrical Interface Bluetooth® Software Supported Link Topology Power Management Certifications Power Management	with a maximum tra Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend USB 2.0 compliant Microsoft Windows Microsoft Windows FCC (47 CFR) Part 1 ETS 300 328, ETS 3 Low Voltage Direct UL, CSA, and CE Mai BT4.1-ESR 5/6/7 CC LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle	Bluetooth® Software ACPI, and USB Bus Support 5C, Section 15.247 & 15.249 00 826 ive IEC950 ·k ompliance	

Technical Specifications	Technica	l Speci	ficat	ions
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Bluetooth® Profiles Supported	Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy LE Privacy 1.2 -Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX)
	FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

INPUT / OUTPUT DEVICES

HP USB Business Slim	USB Keyboard		
	Keys	104, 105, 106, 107, 109 layout (depending upon country)	
Physical characteristics	Dimensions (L x W x H)	171.97 x 68.35 x 8.27 in (436.8± 1.5 x 137.6± 1.0 x 21.0± 1.0 cm)	
	Weight	1.32 lb (0.6± 0.08 kg)	
	Operating voltage	+ 4.4 - 5.25VDC	
	Power consumption	50-mA maximum (with 5 VDC power supplied and three LEDs ON)	
	System interface	USB Type A plug connector	
Electrical	ESD	Contact Discharge: 2, 4,6,8KV Air Discharge: 2, 4, 8,10,12.5KV	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft® PC 99 - 2001	Functionally compliant	
	Keycaps	Low-profile design	
	Switch actuation	60±12.5g nominal peak force with tactile feedback	
	Switch life	10 million keystrokes (Life tester)	
Mechanical	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	



	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	30 in (76.2 cm) on concrete, 16-drop sequence	
Approvals	UL, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		
Kit contents	Keyboard	Installation Guide	
	Warranty Card	Safety and Comfort Guide	

HP USB Mouse			
Dimensions (H x L x W)	2.5 x 4.5 x 1.5 in (63.	2.5 x 4.5 x 1.5 in (63.5 x 114.3 x 38.1 mm)	
Weight	0.22 lb (99.79 g)	0.22 lb (99.79 g)	
Color	Black	Black	
Connector	USB	USB	
Mechanical	Resolution	Resolution 800 DPI sensitivity	
	Buttons	Two primary buttons and clickable scroll wheel	

After Market Options

Memory	Part Number	
HP 4GB DDR4-2400 SODIMM	Z9H55AA	
HP 8GB DDR4-2400 SODIMM	Z9H56AA	
HP 16GB DDR4-2400 SODIMM	Z9H53AA	
HP 16GB DDR4-2666 SODIMM	3TK84AA	
HP 4GB DDR4-2666 SODIMM	3TK86AA	
HP 8GB DDR4-2666 SODIMM	3TK88AA	
Storage	JL	
HP 256GB SATA TLC Non-SED Solid State Drive	P1N68AA	
HP PCIe NVME TLC 256GB SSD M.2 Drive	1CA51AA	
Other	JL	
HP ODD Module	X8U73AA	
HP VESA Plate	X8U74AA	
HP (Bulk) Elite Slice Sata Storage Drive Screws Kit	Z5U26AA	
HP DisplayPort Cable Kit	VN567AA	
HP DisplayPort To HDMI True 4k Adapter	2JA63AA	
Pointing Devices		
HP USB Mouse	QY777AA	
HP 1000dpi Laser Mouse	QY778AT	
Keyboards		
HP USB Business Slim Keyboard	N3R87AA	
HP Wireless Business Slim Keyboard and Mouse		

Summary of Changes

Date of change:	Version History:	Description of change:
	V1 to V2	

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